

General Description

The AO4496 uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$ with low gate charge. This device is suitable for use as a DC-DC converter application.

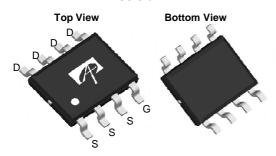
Product Summary

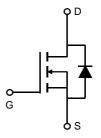
 $V_{DS}(V) = 30V$ $I_{D} = 10A$ $\begin{array}{ll} I_D = 10 \text{A} & (V_{GS} = 10 \text{V}) \\ R_{DS(ON)} < 19.5 \text{m}\Omega & (V_{GS} = 10 \text{V}) \\ R_{DS(ON)} < 26 \text{m}\Omega & (V_{GS} = 4.5 \text{V}) \end{array}$

100% UIS Tested 100% Rg Tested



SOIC-8





Absolute Maximum Ratings T_J=25°C unless otherwise noted

| Parameter | | Symbol | Maximum | Units | | |
|--|----------------------|-----------------------------------|------------|-------|--|--|
| Drain-Source Voltage | | V _{DS} | 30 | V | | |
| Gate-Source Voltage | | V_{GS} | ±20 | V | | |
| Continuous Drain | T _A =25°C | 10 | | | | |
| Current ^A | T _A =70°C | I _D | 7.5 | | | |
| Pulsed Drain Current B | | I _{DM} | 50 | A | | |
| Avalanche Current ^G | | I _{AR} | 17 | | | |
| Repetitive avalanche energy L=0.1mH ^G | | E _{AR} | 14 | mJ | | |
| Power Dissipation ^A | T _A =25°C | В | 3.1 | W | | |
| | T _A =70°C | $-P_{D}$ | 2.0 |] | | |
| Junction and Storage Temperature Range | | T _J , T _{STG} | -55 to 150 | °C | | |

| Thermal Characteristics | | | | | | | | |
|---------------------------------------|--------------|-----------------|-----|-------|------|--|--|--|
| Parameter | Symbol | Тур | Max | Units | | | | |
| Maximum Junction-to-Ambient A | t ≤ 10s | | 31 | 40 | °C/W | | | |
| Maximum Junction-to-Ambient A | Steady State | $R_{\theta JA}$ | 59 | 75 | °C/W | | | |
| Maximum Junction-to-Lead ^C | Steady State | $R_{	hetaJL}$ | 16 | 24 | °C/W | | | |

Electrical Characteristics (T_J=25°C unless otherwise noted)

| Symbol | Parameter | r Conditions | | Тур | Max | Units |
|-----------------------|---------------------------------------|---|--|------|------|-------|
| STATIC F | PARAMETERS | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0 V$ | 30 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 30V, V_{GS} = 0V$ | _S = 30V, V _{GS} = 0V | | 1 | μА |
| | | $T_J = 55$ °C | | | 5 | μΛ |
| I_{GSS} | Gate-Body leakage current | $V_{DS} = 0V$, $V_{GS} = \pm 20V$ | | | ±100 | nA |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS} I_D = 250 \mu A$ | 1.4 | 1.8 | 2.5 | V |
| I _{D(ON)} | On state drain current | $V_{GS} = 10V, V_{DS} = 5V$ | 50 | | | Α |
| | Static Drain-Source On-Resistance | $V_{GS} = 10V, I_D = 10A$ | | 16 | 19.5 | |
| R _{DS(ON)} | | T _J =125°C | | 24 | 29 | mΩ |
| | | $V_{GS} = 4.5V, I_D = 7.5A$ | | 21 | 26 | |
| g FS | Forward Transconductance | $V_{DS} = 5V, I_{D} = 10A$ | | 30 | | S |
| V_{SD} | Diode Forward Voltage | $I_S = 1A, V_{GS} = 0V$ | | 0.76 | 1 | V |
| I _S | Maximum Body-Diode Continuous Current | | | | 3 | Α |
| DYNAMIC | PARAMETERS | | | | | |
| C _{iss} | Input Capacitance | | | 550 | 715 | pF |
| C _{oss} | Output Capacitance | V_{GS} =0V, V_{DS} =15V, f=1MHz | | 110 | | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 55 | | pF |
| R_g | Gate resistance | V_{GS} =0V, V_{DS} =0V, f=1MHz | 3 | 4 | 4.9 | Ω |
| SWITCHI | NG PARAMETERS | | | | | |
| Q _g (10V) | Total Gate Charge | | | 9.8 | 13 | nC |
| Q _g (4.5V) | Total Gate Charge | V _{GS} =10V, V _{DS} =15V, I _D =10A | | 4.6 | 6.1 | nC |
| Q_{gs} | Gate Source Charge | V _{GS} =10V, V _{DS} =13V, I _D =10A | | 1.8 | | nC |
| Q_{gd} | Gate Drain Charge | 1 | | 2.2 | | nC |
| t _{D(on)} | Turn-On DelayTime | | | 5 | | ns |
| t _r | Turn-On Rise Time | V_{GS} =10V, V_{DS} =15V, R_{L} = 1.5 Ω , | | 3.2 | | ns |
| t _{D(off)} | Turn-Off DelayTime | $R_{GEN}=3\Omega$ | | 24 | | ns |
| t _f | Turn-Off Fall Time | 7 | | 6 | | ns |
| t _{rr} | Body Diode Reverse Recovery Time | I _F =10A, dI/dt=500A/μs | | 22 | 29 | ns |
| Q_{rr} | Body Diode Reverse Recovery Charge | I _F =10A, dI/dt=500A/μs | | 14 | | nC |

A: The value of R $_{\theta,JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^{\circ}$ C. The value in any given application depends on the user's specific board design.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

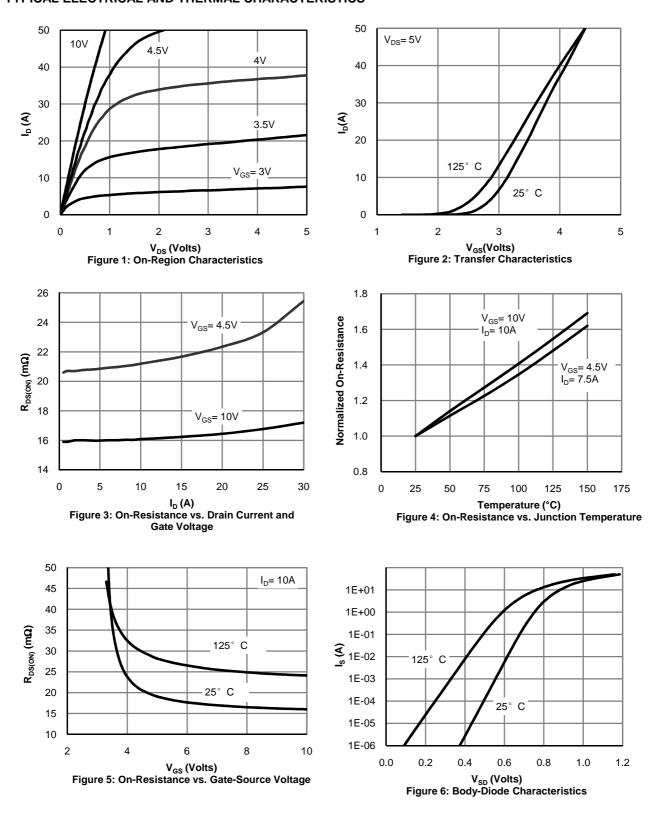
D. The static characteristics in Figures 1 to 6 are obtained using t \leqslant 300 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The SOA curve provides a single pulse rating.

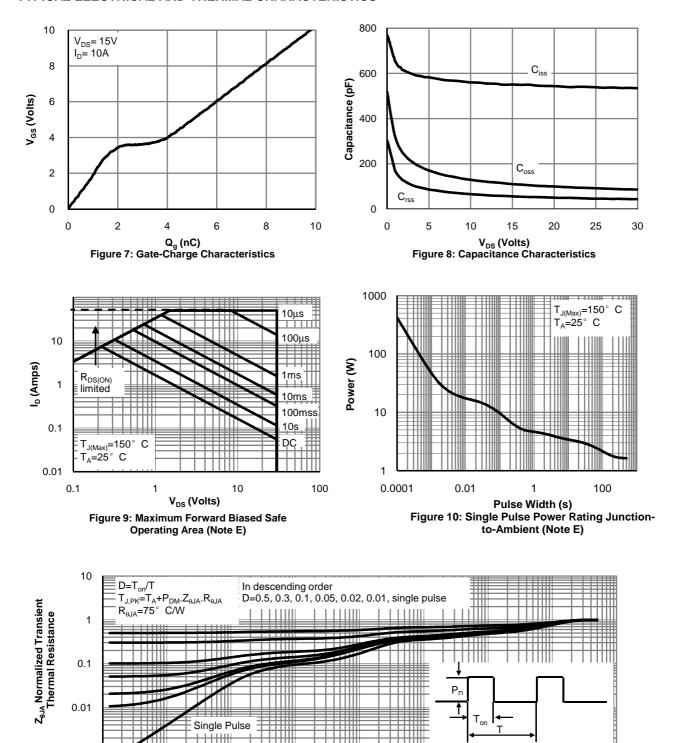
F. The current rating is based on the $t \le 10s$ thermal resistance rating.

G. E_{AR} and I_{AR} ratings are based on low frequency and duty cycles to keep T_j =25C.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)

0.1

0.01

0.001

0.00001

0.0001

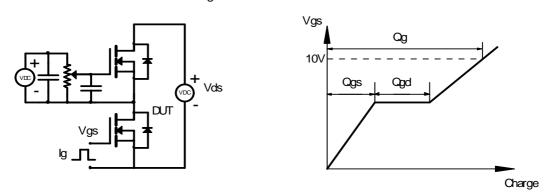
0.001

1000

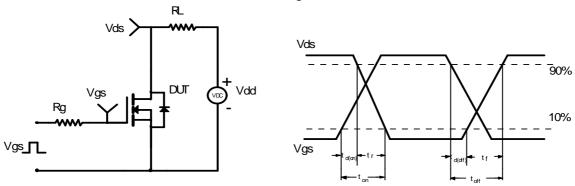
100

10

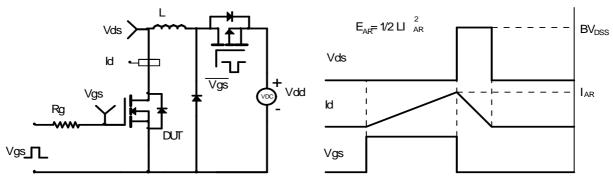
Gate Charge Test Circuit & Waveform



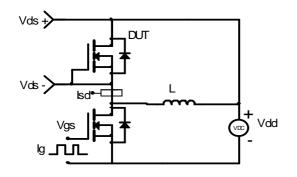
Resistive Switching Test Circuit & Waveforms

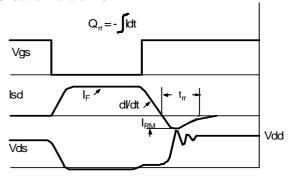


Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms





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